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**General Information**

Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
Typical Component Weight	540 mg
Shelf Life	78 Weeks
MSL	1

**Specifications**

Capacitance	0.056 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	17.8571 GOhms

Dimensions	
L	7.1mm +/-0.4mm
W	6.1mm +/-0.4mm
T	2.5mm +/-0.20mm
S	4.2mm MIN
B	1.27mm +/-0.4mm
Case Code (EIA / mm)	2824 / 7260

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	300

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